

Transmitted herewith for filing is the Patent Application of:

Inventor: HSIEN-PING FENG, JUNG-CHIH TSAO, HSI-KUEI CHENG, CHIH-TSUNG LEE, MING-YUAN CHEN, STEVEN LIN, RAY

## **CHUANG, CHI-WEN LIU**

Enclosed are:

For: POST ECP MULTI-STEP ANNEAL/H2 TREATMENT TO REDUCE FILM IMPURITY

					23.	
x sheets of drawing(s) - formal.						
X An assign	X An assignment of the invention to Taiwan Semiconductor Manufacturing Co.					
An associate power of attorney Applicant claims small entity status						
Request & Certification under 35 USC 122(b)(2)(b)(i)						
The filing fee has be	een calculated as shown be	elow:				
	(Col. 1)	(Col. 2) OTHER		AN A SMALL ENTITY		
FOR:	NO. FILED	NO. EXTRA	RATE	FEE		
BASIC FEE				\$ 770.		
TOTAL CLAIMS	39 -20=	19	x 18 =	\$ 342.		
INDEP CLAIMS	4 -3=	11	x 86 =	\$ 86.		
			SUB TOTAL	\$ 1,198.		
			ASSIGNMENT	\$40.		
TOTAL \$ 1.238.						
Please charge my Deposit Account No. 19-0033 in the amount of \$ 1,238. A duplicate copy of this sheet is enclosed.						
The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any						
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## **EXPRESS MAIL CERTIFICATE**

Express Mail No. EV319114127US

I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA, 22313-1450. Applicant and/or attorney requests the date of deposit as the Filing Date.

of deposit

X Any additional filing fees required under 37 CFR §1.16.

Any patent application processing fees under 37 CFR §1.17.